onsemi

ESD Protection Diode

Ultra-Low Capacitance Micro-Packaged Diodes for ESD Protection

ESD7410

The ESD7410 is designed to protect voltage sensitive components that require ultra-low capacitance from ESD and transient voltage events. It has industry leading capacitance linearity over voltage making it ideal for RF applications. This capacitance linearity combined with the extremely small package and low insertion loss makes this part well suited for use in antenna line applications for wireless handsets and terminals.

Features

- Ultra-Low Capacitance: < 1.0 pF Max
 Industry Leading Capacitance Linearity Over Voltage
- Insertion Loss: 0.1 dB at 1 GHz; 0.3 dB at 3 GHz
- Low Leakage: < 1 μA
- IEC61000-4-2 (ESD): Level 4 ±30 kV Contact
- ISO 10605 (ESD) 330 pF/2 k $\Omega \pm 30$ kV Contact
- SZESD7410MXWT5G Wettable Flank Package for optimal Automated Optical Inspection (AOI)
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- RF Signal ESD Protection
- Active Antenna ESD Protection
- Near Field Communications

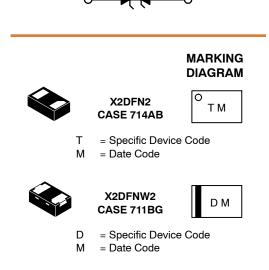
MAXIMUM RATINGS (T_A = 25° C unless otherwise noted)

		•	
Rating	Symbol	Value	Unit
IEC 61000–4–2 Contact (Note 1) IEC 61000–4–2 Air ISO 10605 Contact (330 pF / 330 Ω) ISO 10605 Contact (330 pF / 2 k Ω) ISO 10605 Contact (150 pF / 2 k Ω)	ESD	±30 ±30 ±30 ±30 ±30	kV kV kV kV kV
Total Power Dissipation (Note 2) @ T _A = 25°C Thermal Resistance, Junction-to-Ambient	$P_D \ R_{\theta J A}$	300 400	mW °C/W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C
Lead Solder Temperature – Maximum (10 Second Duration)	ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Non-repetitive current pulse at $T_A = 25^{\circ}C$, per IEC61000-4-2 waveform.

2. Mounted with recommended minimum pad size, DC board FR-4



ORDERING INFORMATION

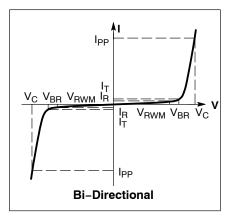
Device	Package	Shipping [†]
ESD7410N2T5G	X2DFN2 (Pb-Free)	8000 / Tape & Reel
SZESD7410N2T5G	X2DFN2 (Pb-Free)	8000 / Tape & Reel
ESD7410MXWT5G	X2DFNW2 (Pb-Free)	8000 / Tape & Reel
SZESD7410MXWT5G	X2DFNW2 (Pb-Free)	8000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS

(T_A = 25°C unless otherwise noted)

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Symbol	Parameter
I _{PP}	Maximum Reverse Peak Pulse Current
V _C	Clamping Voltage @ I _{PP}
V _{RWM}	Working Peak Reverse Voltage
I _R	Maximum Reverse Leakage Current @ V _{RWM}
V _{BR}	Breakdown Voltage @ I _T
Ι _Τ	Test Current



*See Application Note AND8308/D for detailed explanations of datasheet parameters.

Parameter Sym		Condition	Min	Тур	Max	Unit
Reverse Working Voltage	V _{RWM}				9.5	V
Breakdown Voltage	V _{BR}	I _T = 1 mA (Note 3)	10			V
Reverse Leakage Current	I _R	V _{RWM} = 9.5 V			1.0	μΑ
Clamping Voltage	V _C	IEC 61000-4-2, ±8 kV Contact	See Figures 1 and 2		V	
Clamping Voltage, TLP (Note 4) V _C		Ipp = 8 A Ipp = 16 A Ipp = -8 A Ipp = -16 A		18 20 -18 -20		V
Reverse Peak Pulse Current	I _{PP}	IEC 61000-4-2 (8/20 μs)	5.0			Α
Clamping Voltage (8/20 μs) V _C		I _{PP} = 5.0 A		18.4	19.4	V
Dynamic Resistance R _{DYN}		TLP Pulse		1.0		Ω
Junction Capacitance	CJ	$V_R = 0 V$, f = 1 MHz $V_R = 0 V$, f = 1 GHz		0.40 0.35	1.0 0.7	pF
Insertion Loss f = 1 GHz f = 3 GHz				0.1 0.3		dB

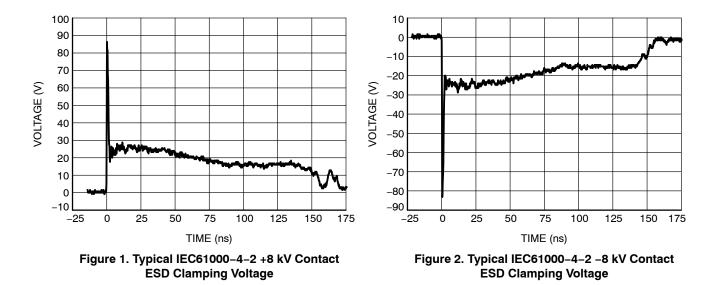
FI ECTRICAL CHARACTERISTICS (T. 25°C unless otherwise noted)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Breakdown voltage is tested from pin 1 to 2 and pin 2 to 1.

4. ANSI/ESD STM5.5.1 – Electrostatic Discharge Sensitivity Testing using Transmission Line Pulse (TLP) Model. TLP conditions: $Z_0 = 50 \Omega$, $t_p = 100$ ns, $t_r = 4$ ns, averaging window; $t_1 = 30$ ns to $t_2 = 60$ ns.

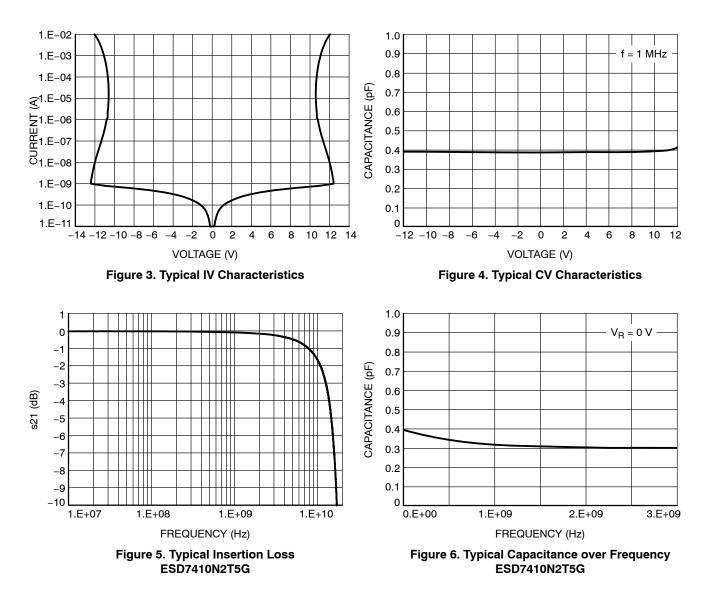
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TYPICAL CHARACTERISTICS



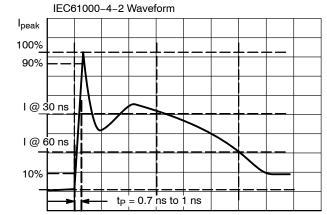
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TYPICAL CHARACTERISTICS



IEC 61000-4-2 Spec.

Level	Test Volt- age (kV)	First Peak Current (A)	Current at 30 ns (A)	Current at 60 ns (A)
1	2	7.5	4	2
2	4	15	8	4
3	6	22.5	12	6
4	8	30	16	8





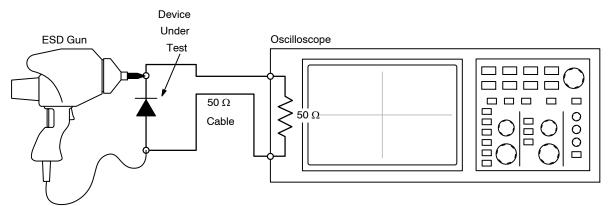


Figure 8. Diagram of ESD Clamping Voltage Test Setup

The following is taken from Application Note AND8308/D – Interpretation of Datasheet Parameters for ESD Devices.

ESD Voltage Clamping

For sensitive circuit elements it is important to limit the voltage that an IC will be exposed to during an ESD event to as low a voltage as possible. The ESD clamping voltage is the voltage drop across the ESD protection diode during an ESD event per the IEC61000–4–2 waveform. Since the IEC61000–4–2 was written as a pass/fail spec for larger

systems such as cell phones or laptop computers it is not clearly defined in the spec how to specify a clamping voltage at the device level. ON Semiconductor has developed a way to examine the entire voltage waveform across the ESD protection diode over the time domain of an ESD pulse in the form of an oscilloscope screenshot, which can be found on the datasheets for all ESD protection diodes. For more information on how ON Semiconductor creates these screenshots and how to interpret them please refer to AND8307/D.

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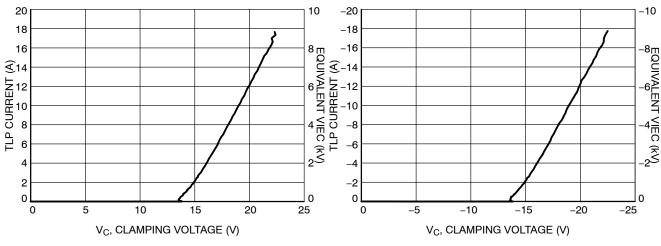
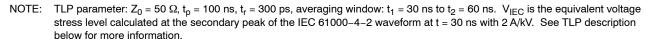


Figure 9. Positive TLP I-V Curve

Figure 10. Negative TLP I-V Curve



Transmission Line Pulse (TLP) Measurement

Transmission Line Pulse (TLP) provides current versus voltage (I–V) curves in which each data point is obtained from a 100 ns long rectangular pulse from a charged transmission line. A simplified schematic of a typical TLP system is shown in Figure 11. TLP I–V curves of ESD protection devices accurately demonstrate the product's ESD capability because the 10s of amps current levels and under 100 ns time scale match those of an ESD event. This is illustrated in Figure 12 where an 8 kV IEC 61000–4–2 current waveform is compared with TLP current pulses at 8 A and 16 A. A TLP I–V curve shows the voltage at which the device turns on as well as how well the device clamps voltage over a range of current levels.

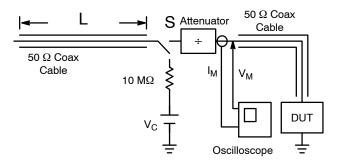


Figure 11. Simplified Schematic of a Typical TLP System

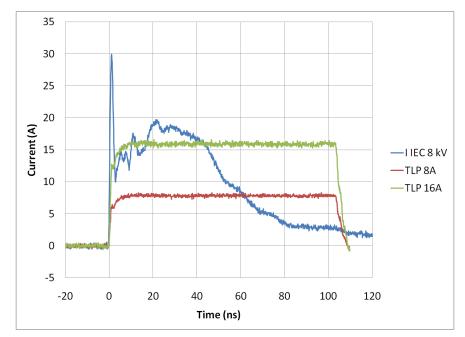
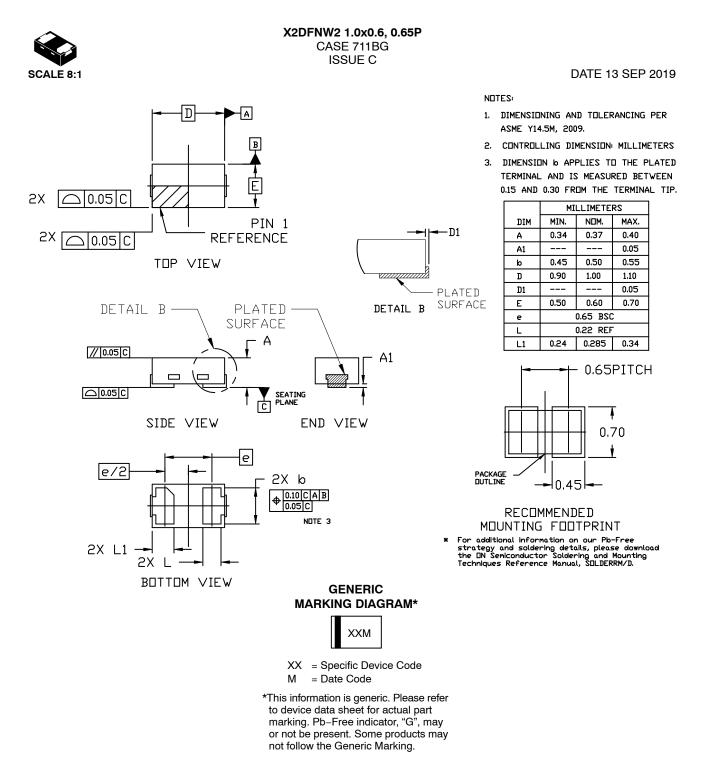


Figure 12. Comparison Between 8 kV IEC 61000-4-2 and 8 A and 16 A TLP Waveforms





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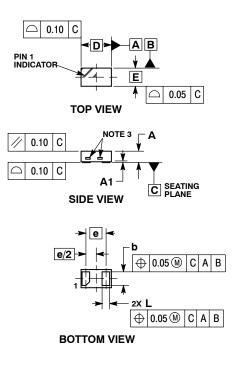
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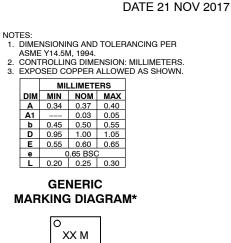
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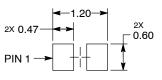
SCALE 8:1





XX = Specific Device Code M = Date Code

RECOMMENDED SOLDER FOOTPRINT*



DIMENSIONS: MILLIMETERS

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

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